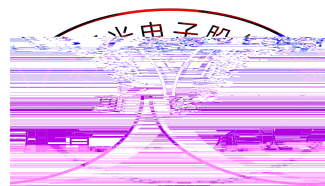


# SPECIFICATION



Mass Production





# 1. Description

## 1.1

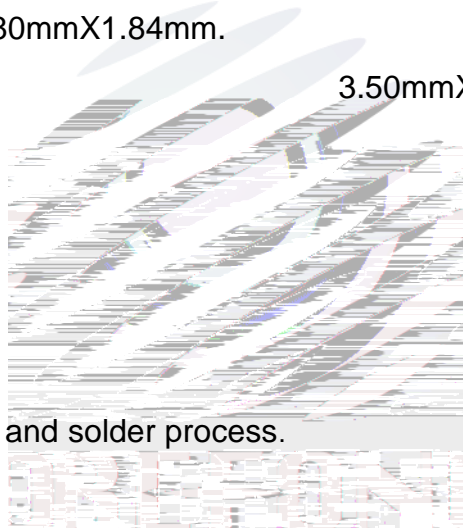


The Green source color devices are made with InGaN on Substrate Light Emitting Diode .

Product Package:3.50mmX2.80mmX1.84mm.

GaN

3.50mmX2.80mmX1.84mm.



## 1.2 Features

PLCC2 Package.

Extremely wide viewing angle.

Suitable for all SMT assembly and solder process.

Available on tape and reel.

Moisture sensitivity level: Level 2.

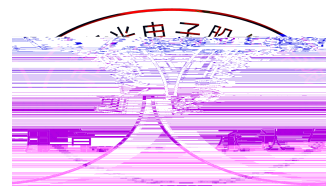
Compliance with RoHS and REACH. 符合RoHS和REACH要求

Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101 Stress Test Qualification for Automotive Grade Discrete Semiconductors

## 1.3 Application

Automotive Interior Lighting. 汽 内 照 明

Switches. 开 关



### 1.4 Package Dimension

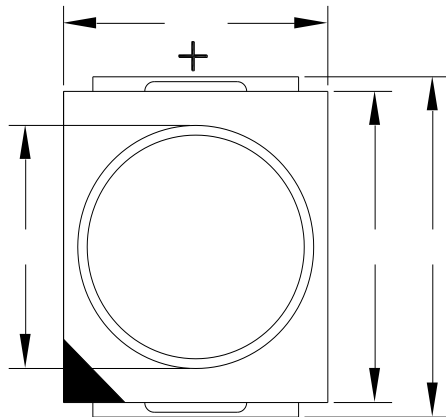


Fig.1-1 Top View

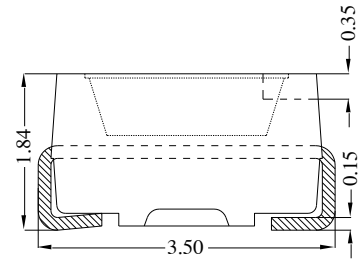


Fig.1-2 Side View

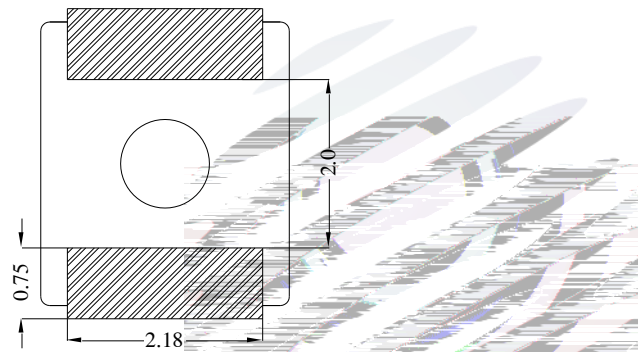


Fig.1-3 Bottom View

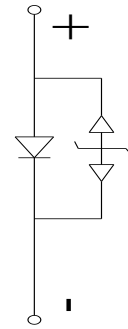


Fig.1-4 Polarity

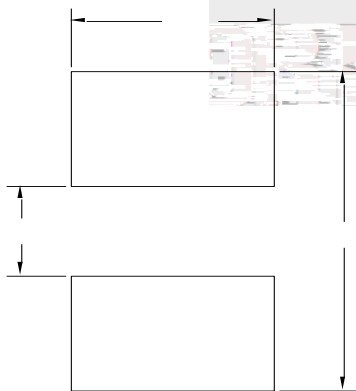
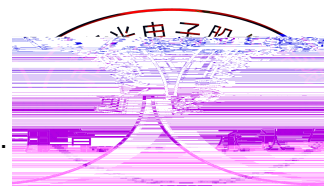


Fig.1-5 Soldering Patterns

#### Notes

All dimensions units are millimeters.

All dimensions tolerances are  $\pm 0.2\text{mm}$  unless otherwise noted.



## 1.5 Product Parameters

 Table 1-1 Electrical / Optical Characteristics at  $T_s=25^{\circ}\text{C}$ 

Item	Symbol	Test Condition	Value			Unit
			Min.	Typ.	Max.	
Forward Voltage	$V_F$	$I_F=20\text{mA}$	2.8	3.2	3.4	V
Reverse Current	$I_R$	$V_R=5\text{V}$	Not designed for reverse operation			$\mu\text{A}$
Luminous Intensity	$I_V$	$I_F=20\text{mA}$	900	1200	1500	mcd
Dominant wavelength	$\lambda_d$	$I_F=20\text{mA}$	520	521	525	nm
Viewing Angle		$I_F=20\text{mA}$	---	120	---	deg
Thermal Resistance.	$R_{THJ-S}$	$I_F=20\text{mA}$	---	---	300	$^{\circ}\text{C}/\text{W}$

 Table 1-2 Absolute Maximum Ratings at  $T_s=25^{\circ}\text{C}$ 

Parameter	Symbol	Rating	Units
Power Dissipation	$P_D$	102	mW
Forward Current	$I_F$	30	mA
Peak Forward Current	$I_{FP}$	100	mA
Reverse Voltage	$V_R$	Not designed for reverse operation	
Electrostatic Discharge (HBM)	$E_{SD}$	8000	V

## Notes

1. 1/10 Duty cycle, 10ms pulse width.
2. The above forward voltage measurement allowance tolerance is  $\pm 0.1V$ .
3. The above color coordinates measurement allowance tolerance is 0.005.
4. The above luminous intensity measurement allowance tolerance  $\pm 10\%$ .
5. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.



## 1.7 Typical Optical Characteristics Curves

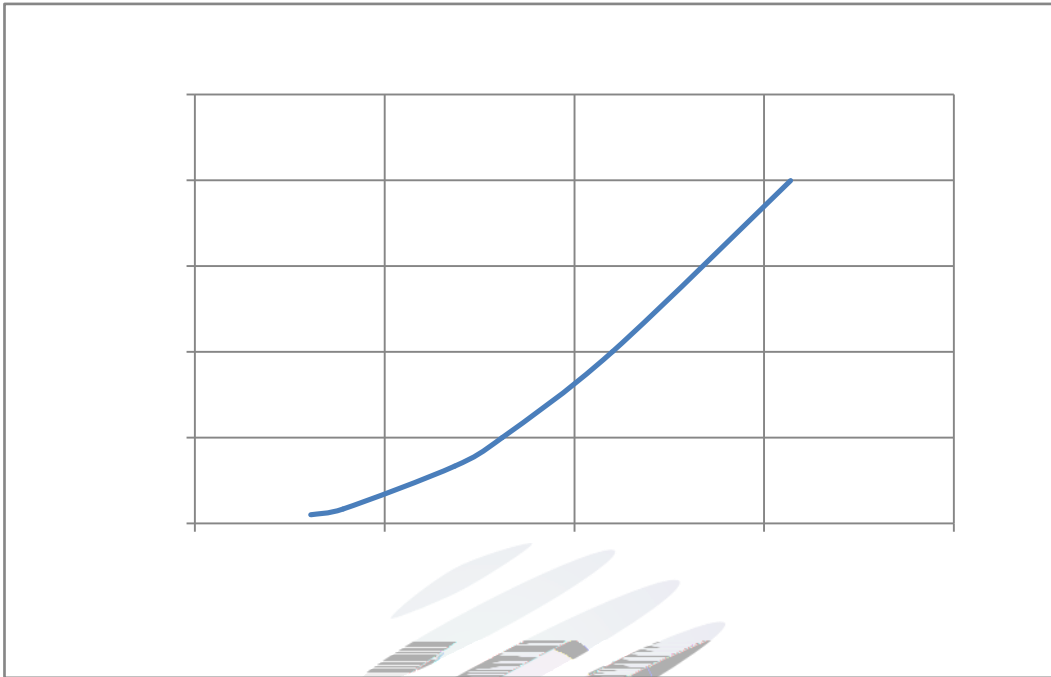


Fig. 1-7 Forward Voltage Vs Forward Current

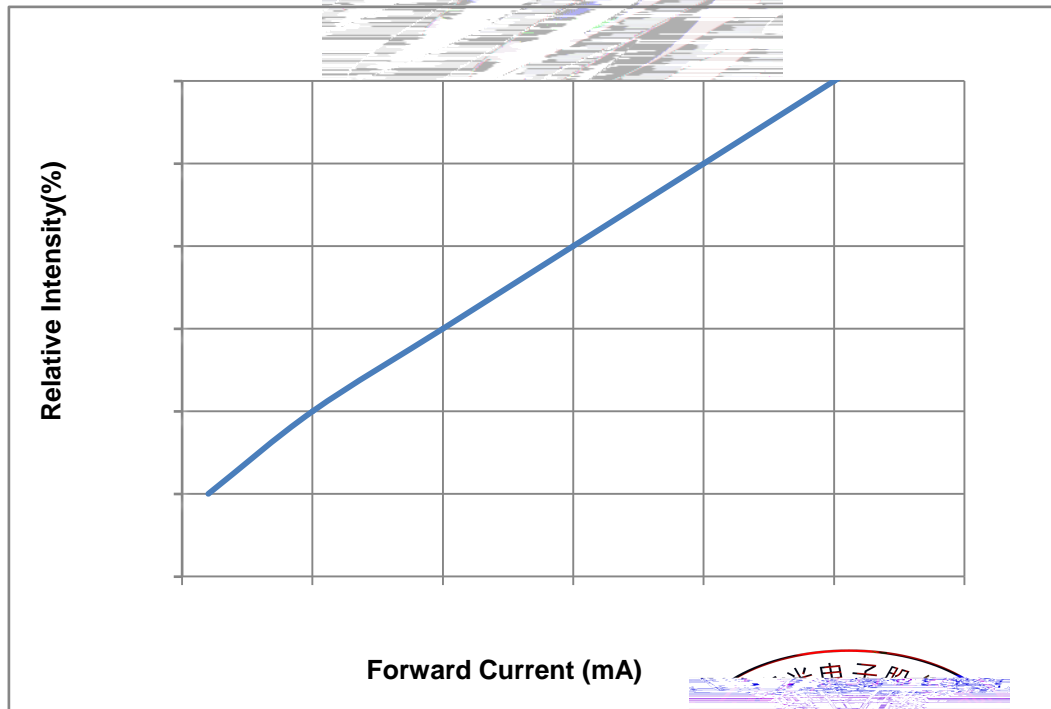


Fig. 1-8 Forward Current Vs Relative Intensity

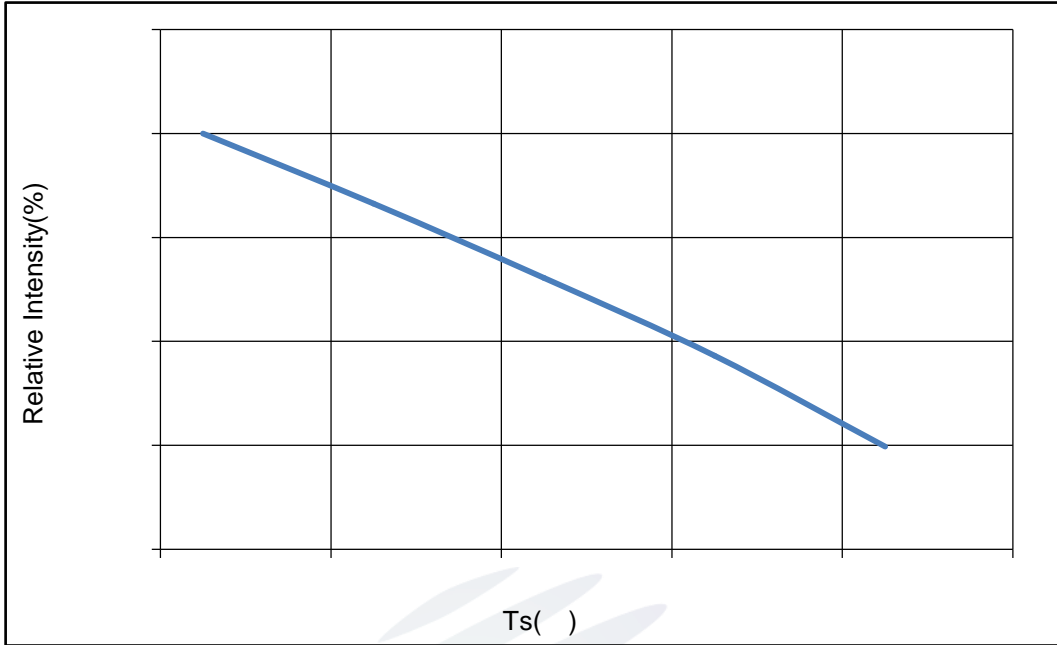


Fig. 1-9 Solder Temperature Vs Relative Intensity

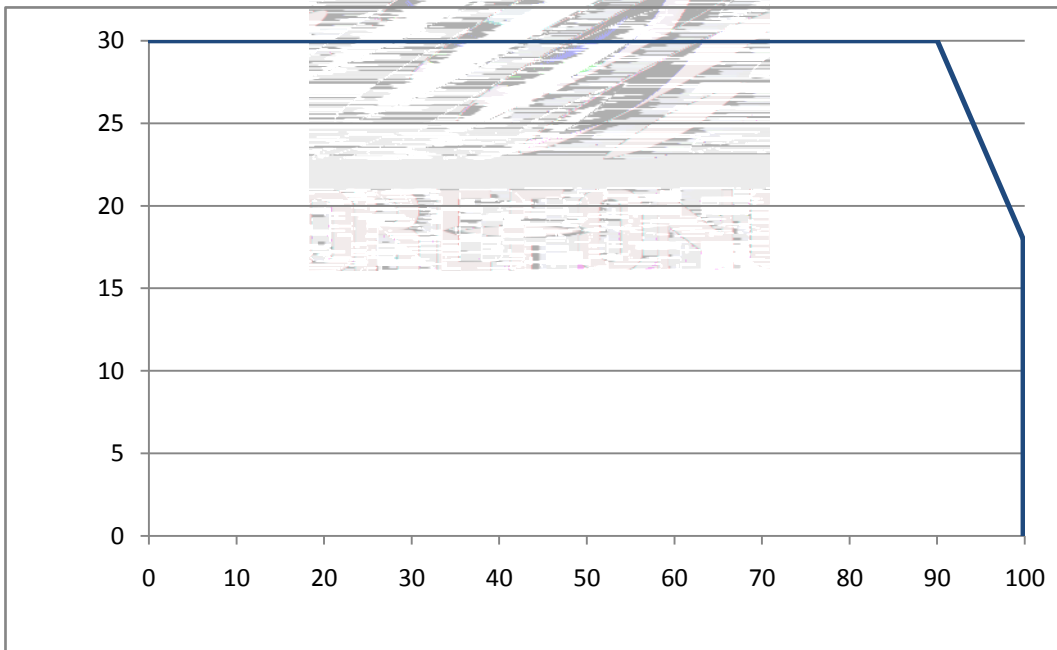
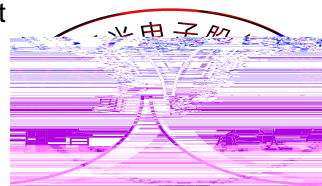


Fig. 1-10 Solder Temperature Vs Forward Current





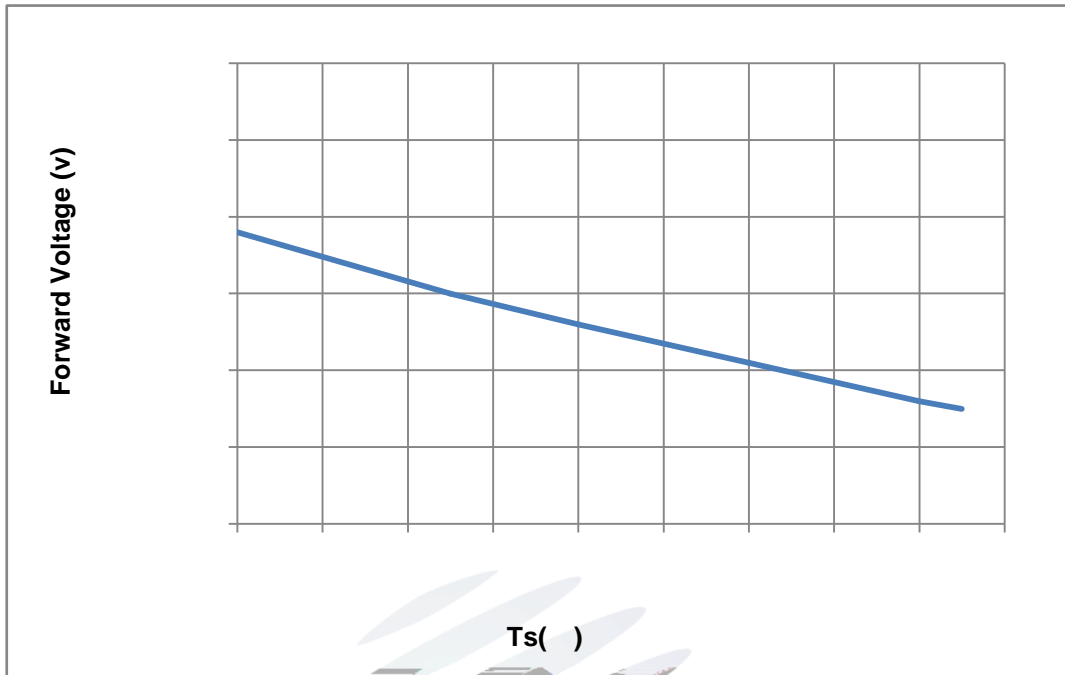


Fig. 1-11 Forward Voltage Vs Solder Temperature

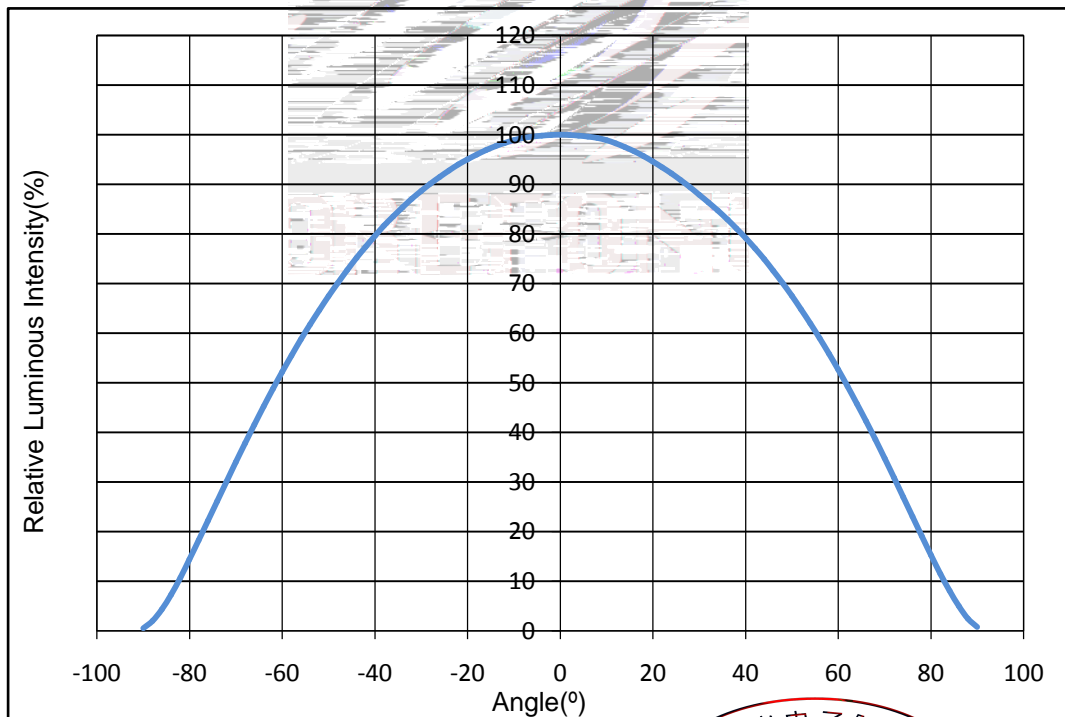
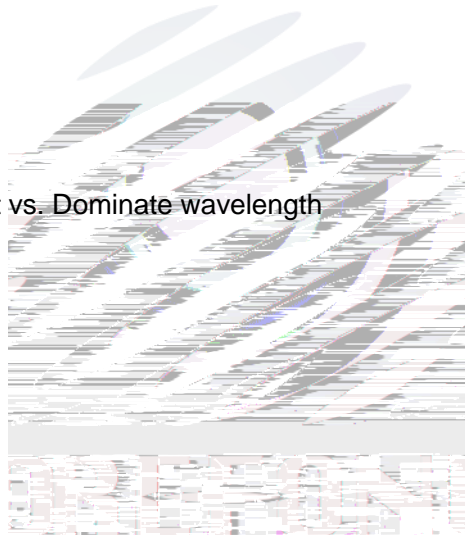


Fig. 1-12 Radiation diagram



Fig. 1-13 Forward current vs. Dominate wavelength



## 2. Packaging

### 2.1 Packaging Specification

Package:2000pcs/reel. 2000pcs

#### 2.1.1 Carrier Tape Dimension

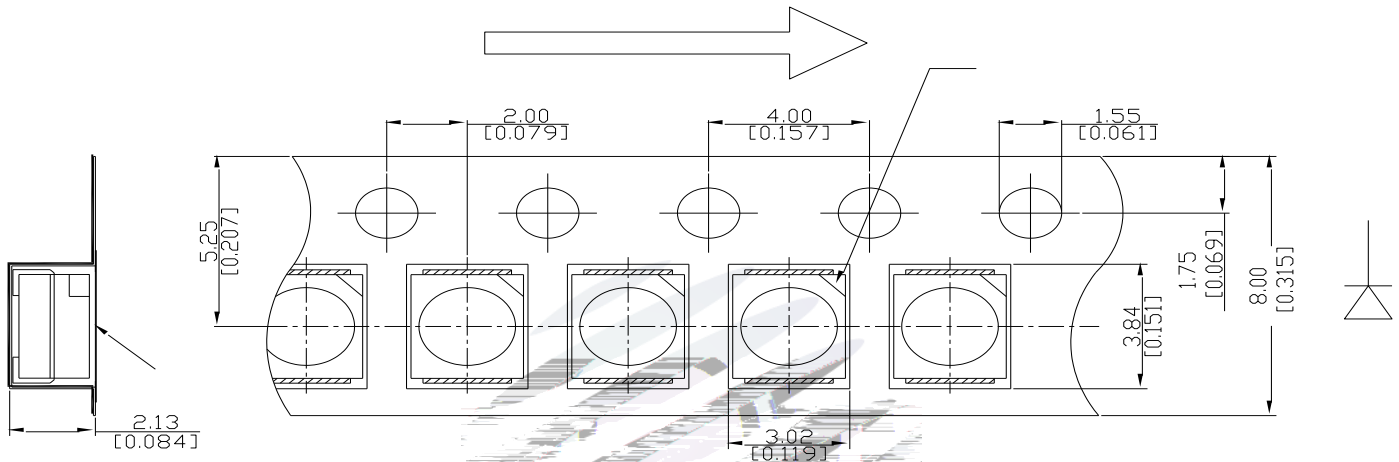


Fig.2-1 Carrier Tape Dimension

#### 2.1.2 Reel Dimension

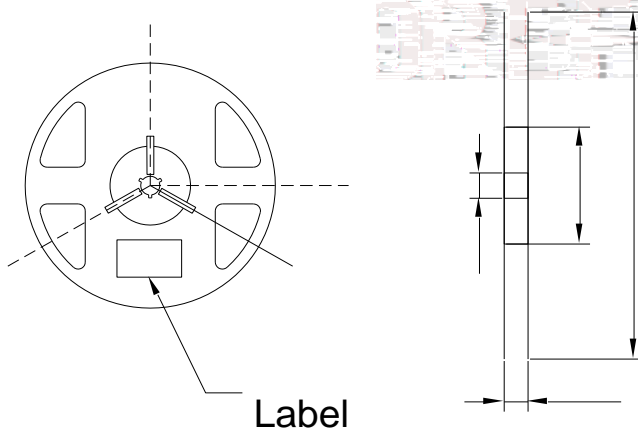


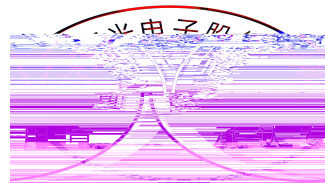
Fig.2-2 Reel Dimension

Reel Dimension

A	8.0 0.1mm
B	178 1mm
C	60 1mm
D	13.0 0.5mm

#### Notes

The tolerances unless mentioned  $\pm 0.1\text{mm}$ . Unit : mm



### 2.1.3 Label Form Specification



Fig. 2-3 Label Form Specification

#### Specification

PART NO.	Part Number
SPEC NO.	Spec Number
LOT NO.	Lot Number
BIN CODE	Bin Code
	Luminous flux
XY	Chromaticity Bin
V <sub>F</sub>	Forward Voltage
WLD	Wavelength
QTY	Packing Quantity
DATE	Made Date

### 2.2 Moisture Resistant Packing

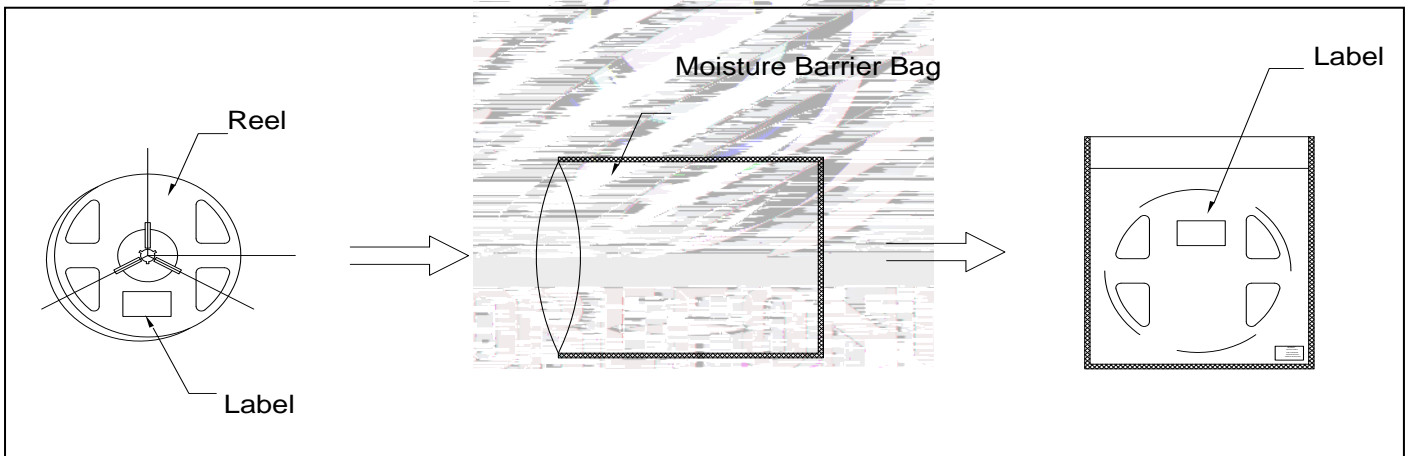
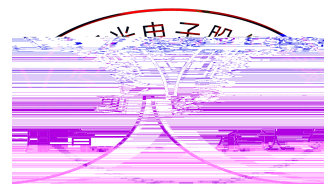


Fig.2-4 Moisture Resistant Packing



## 2.3 Cardboard Box

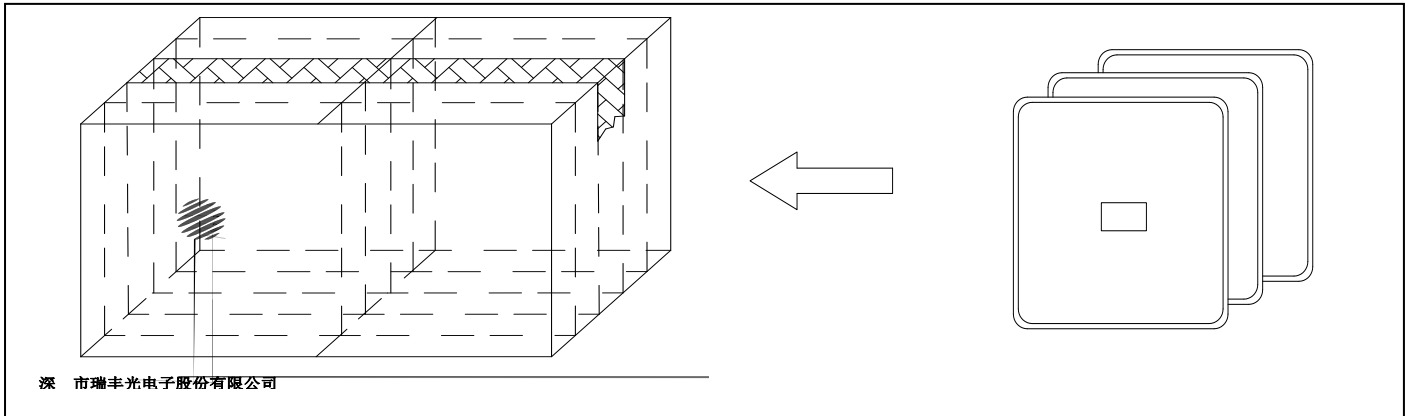


Fig.2- Cardboard Box

## 2.4 Reliability Test Items And Conditions

Table 2-3 Reliability Test Items And Conditions

Test Items	Ref.Standard	Test Condition	Time	Quantity	Ac/Re /
Reflow	JESD22-B106	Temp:260 max T=10 sec	2times	20pcs.	0/1
Thermal Shock	JEITAED-4701 300307	-40 15min 10s 125 15min	1000 cycle	20pcs.	0/1
High Temperature Storage	JEITAED-4701 200 201	Temp:125	1000hrs.	20pcs.	0/1
Low Temperature Storage	JEITA ED-4701 200 202	Temp:-40	1000hrs.	20pcs.	0/1
Life Test	JESD22-A108	Ta=25 If=20mA	1000hrs.	20pcs.	0/1

High Temperature High Humidity Life Test	JESD22-A101	85 / 85%RH I <sub>F</sub> =20mA	1000hrs.	20pcs.	0/1
Temperature Humidity Storage	JEITA ED-4701 100 103	T <sub>A</sub> =85 R <sub>H</sub> =85%	1000hrs.	20pcs.	0/1

## 2.5 Criteria For Judging Damage

Table 2-4 Criteria For Judging Damage

Test Items	Symbol	Test Condition	Criteria For Judgement	
			Min.	Max.
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	-	U.S.L*)x1.1
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5V	-	U.S.L*)x2.0
Luminous Flux		I <sub>F</sub> =20mA	L.S.L*)x0.7	-

### Notes

- 1.U.S.L: Upper standard level                      L.S.L: Lower standard level
- 2.The above reliability tests is based on the verification of a single/strip LED of Refond's existing experimental platform,the reliability experiment was taken under good heat dissipation conditions. when customers applies the LED to the series and parallel circuit, should take consideration of all the factors such as the current, voltage distribution, heat dissipation and others.

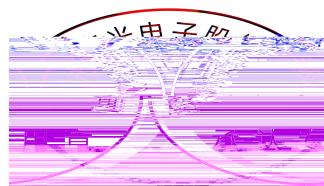




Time limit classification of peak temperature time		
$t_p$	10	Max 10s
( $T_P$ ) 5 °C		Hold time within 5 °C
with the actual peak temperature (TP)	30	







energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. Refond advises against the use of any chemicals or materials that have been found or are suspected to have an adverse affect on device performance or reliability. To verify compatibility, Refond recommends that all chemicals and materials be tested in the specific application and environment for which they are intended to be used. Attaching LEDs, do not use adhesives that outgas organic vapor.

(4) Handle the component along the side surface by using forceps or appropriate tools; Do not directly touch or Handle the silicone lens surface, it may damage the internal circuitry.

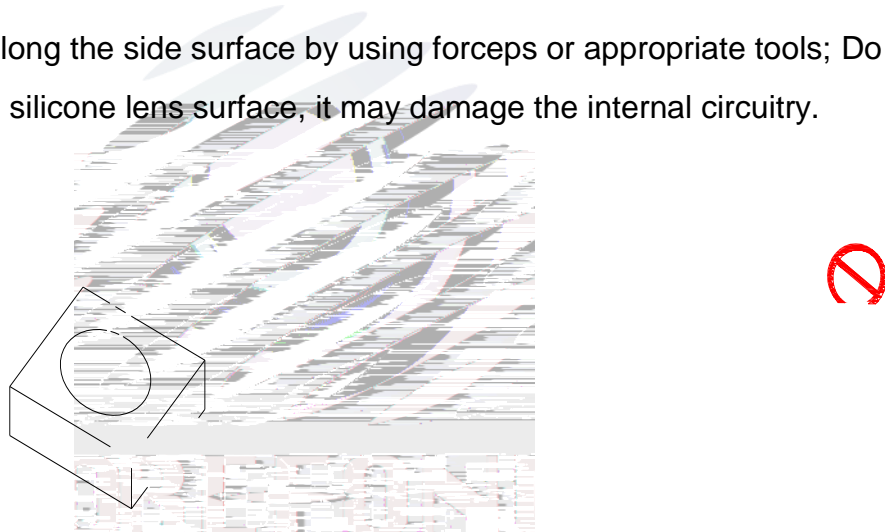
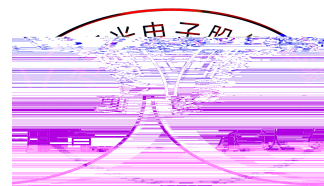


Fig 4-1 Handling Precautions

(5) In designing a circuit, the current through each LED can not exceed the absolute maximum rating specified for each LED. In the mean while, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen. The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.



(6) Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color change and so on. Please consider the heat generation of the LEDs when making the system design. LED

(7) Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust, requiring special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components. Refond suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.



Table 4-1 Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	30	75%	Within 1 Year From Date
	After Opening Aluminum Bag	30	60%	Recommended for use within 24 hours 24

Baking

60 5

following condition 65 5 for above 24 hours.

If the package is flatulence or damaged, please notify the sales staff to assist.





